NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE40H11K uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

● V_{DS} =40V,I_D =110A

 $R_{DS(ON)}$ <4.0m Ω @ V_{GS} =10V

 $R_{DS(ON)}$ <6.5m Ω @ V_{GS} =4.5V

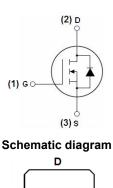
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Load switching
- Hard switched and high frequency circuits
- Uninterruptible power supply



100% ΔVds TESTED!





Marking and pin assignment



TO-252-2L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE40H11K	NCE40H11K	TO-252-2L	-	-	-

Absolute Maximum Ratings (T_C=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	40	V	
Gate-Source Voltage	Vgs	±20	V	
Drain Current-Continuous	I _D	110	Α	
Drain Current-Continuous(Tc=100 ℃)	I _D (100°C)	77.8	Α	
Pulsed Drain Current	I _{DM}	440	Α	
Maximum Power Dissipation	P _D	105	W	
Derating factor		0.7	W/°C	
Single pulse avalanche energy (Note 5)	Eas	540	mJ	
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 175	$^{\circ}$	



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Thermal Characteristic

Thermal Resistance,Junction-to-Case ^(Note 2)	Rejc	1.43	°C/W
Thermal Resistance,Junction-to-Ambient ^(Note 2)	R _{0JA}	55	°C/W

Electrical Characteristics (T_C=25°C unless otherwise noted)

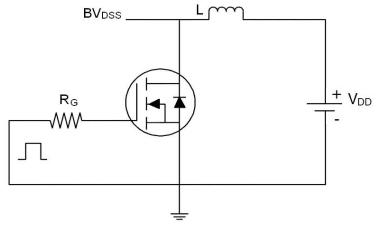
Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics	·						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	40	45	-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =40V,V _{GS} =0V	-	-	1	μA	
Gate-Body Leakage Current	Igss	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA	
On Characteristics (Note 3)							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS},I_{D}=250\mu A$	1.2	1.6	2.5	V	
Davis Course On Otata Basistana		V _{GS} =10V, I _D =20A	-	3.4	4.0	0	
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =10A	-	4.6	6.5	mΩ	
Forward Transconductance	G FS	V _{DS} =10V,I _D =20A	26	-	-	S	
Dynamic Characteristics (Note4)							
Input Capacitance	C _{lss}	\/ 00\/\/ 0\/	-	3650	-	PF	
Output Capacitance	Coss	$V_{DS}=20V, V_{GS}=0V,$	-	382	-	PF	
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	340	-	PF	
Switching Characteristics (Note 4)							
Turn-on Delay Time	t _{d(on)}		-	14	-	nS	
Turn-on Rise Time	t _r	V_{DD} =20 V , R_L =1 Ω	-	17	-	nS	
Turn-Off Delay Time	$t_{\sf d(off)}$	V_{GS} =10 V , R_{G} =3 Ω	-	50	-	nS	
Turn-Off Fall Time	t _f		-	22	-	nS	
Total Gate Charge	Qg	\/ 00\/ L 00A	-	84		nC	
Gate-Source Charge	Q _{gs}	V _{DS} =20V,I _D =20A,	-	10		nC	
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	22		nC	
Drain-Source Diode Characteristics							
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =20A	-	-	1.2	V	
Diode Forward Current (Note 2)	Is		-	-	110	Α	
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 20A	-	42	-	nS	
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	45	-	nC	
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negl	igible (tur	n-on is do	ominated b	y LS+LD	

Notes:

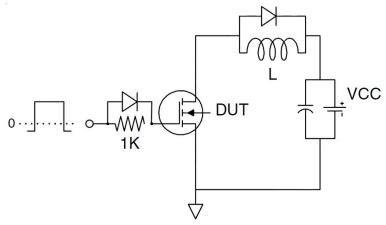
- $\textbf{1.} \ \ \textbf{Repetitive Rating: Pulse width limited by maximum junction temperature.}$
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec. The value of R_{θJA} is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The Power dissipation PDSM is based on R_{θJA} and the maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design, and the maximum temperature of 175°C may be used if the PCB allows it.
- **3.** Pulse Test: Pulse Width ≤ 300μ s, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- $\textbf{5.}~\text{E}_{\text{AS}}~\text{condition}: Tj = 25\,^{\circ}\text{C}, V_{\text{DD}} = 30\text{V}, V_{\text{G}} = 10\text{V}, L = 0.5\text{mH}, Rg = 25\Omega.$

Test circuit

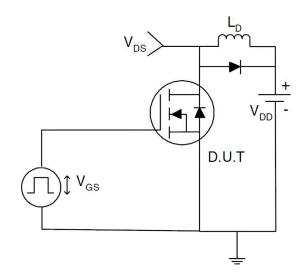
1) E_{AS} Test Circuit



2) Gate Charge Test Circuit



3) Switch Time Test Circuit



Typical Electrical and Thermal Characteristics (Curves)

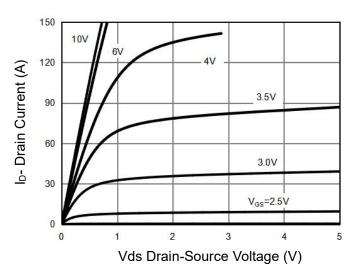


Figure 1 Output Characteristics

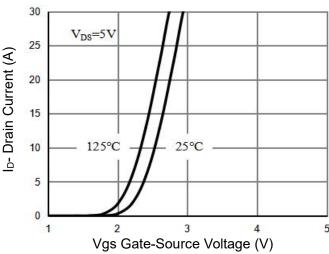


Figure 2 Transfer Characteristics

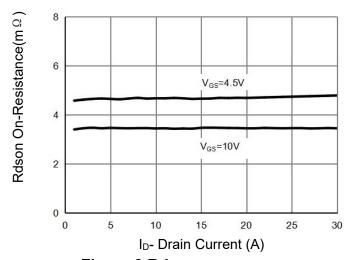


Figure 3 Rdson- Drain Current

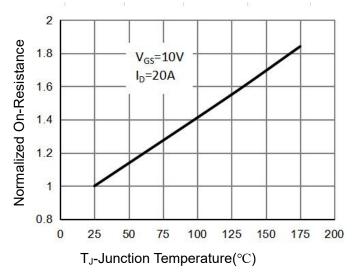


Figure 4 Rdson-JunctionTemperature

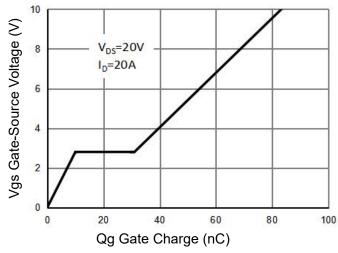


Figure 5 Gate Charge

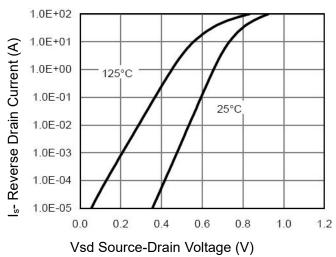


Figure 6 Source- Drain Diode Forward

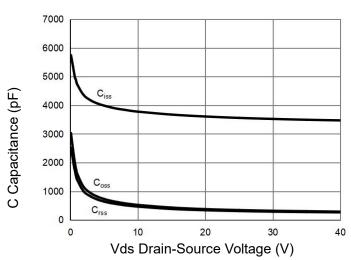


Figure 7 Capacitance vs Vds

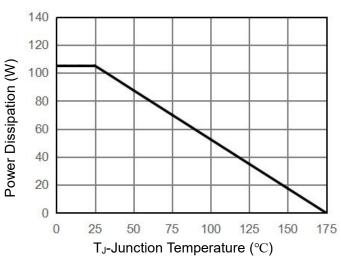


Figure 9 Power De-rating

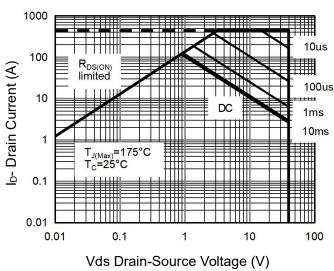


Figure 8 Safe Operation Area

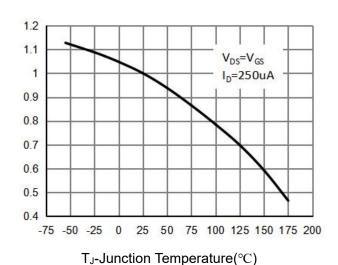


Figure 10 V_{GS(th)} vs Junction Temperature

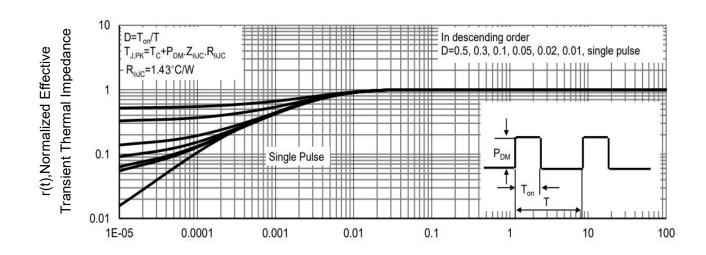
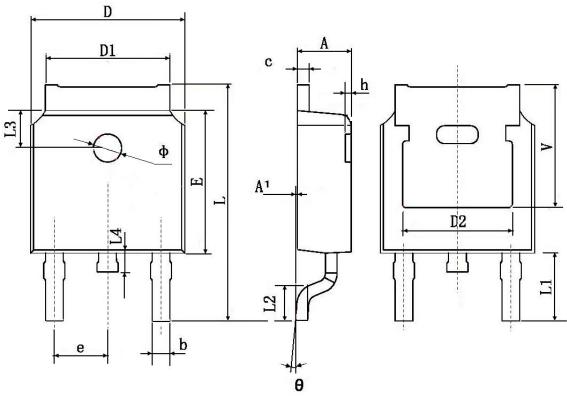


Figure 11 Normalized Maximum Transient Thermal Impedance

Square Wave Pluse Duration(sec)



TO-252 Package Information



0	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	4.83	30 TYP.	0.190 TYP.		
Е	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.900	TYP.	0.114 TYP.		
L2	1.400	1.700	0.055	0.067	
L3	1.600 TYP.		0.063 TYP.		
L4	0.600	1.000	0.024	0.039	
Ф	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.350	TYP.	0.211 TYP.		



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